

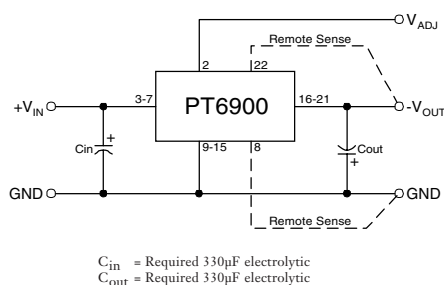
- +5V/+3.3V Input Voltage
- Negative Output
- Remote Sense
- Adjustable Output Voltage
- 23-pin SIP Package

The PT6900 is a series of high-performance ISRs, that provide plus to minus voltage conversion, up to 12 watt in a 23-pin SIP package.

The PT6900 is designed to supply regulated negative voltages for powering the latest ECL (-5.2V) and GaAs (-2.0V) ICs used in high-speed fiber optic communications. A 330μF electrolytic capacitor is required on the input and output for proper operation.

Please note that this product is not short-circuit protected.

## Standard Application



## Pin-Out Information

Pin	Function	Pin	Function
1	Do not connect	13	GND
2	$V_{out}$ Adjust	14	GND
3	$V_{in}$	15	GND
4	$V_{in}$	16	$V_{out}$
5	$V_{in}$	17	$V_{out}$
6	$V_{in}$	18	$V_{out}$
7	$V_{in}$	19	$V_{out}$
8	Remote Sense GND	20	$V_{out}$
9	GND	21	$V_{out}$
10	GND	22	Remote Sense $V_{out}$
11	GND	23	Do not connect
12	GND		

## Ordering Information

+5V Input	+3.3V Input	$V_{out}$
PT6901□	PT6904□	= -2.0V
PT6902□	PT6905□	= -5.2V
PT6903□		= -1.5V

## PT Series Suffix (PT1234X)

## Case/Pin Configuration

Vertical Through-Hole	<b>N</b>
Horizontal Through-Hole	<b>A</b>
Horizontal Surface Mount	<b>C</b>

(For dimensions and PC board layout, see Package Styles 1100 and 1110.)

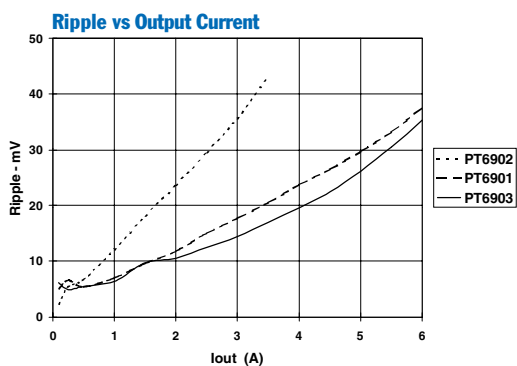
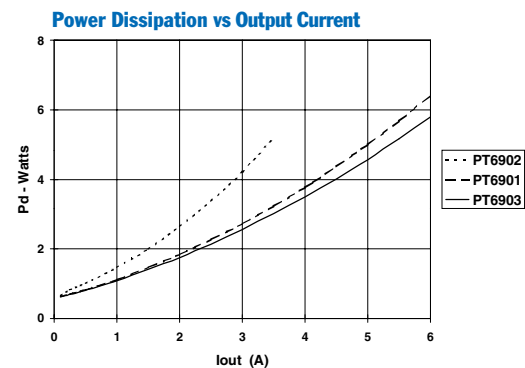
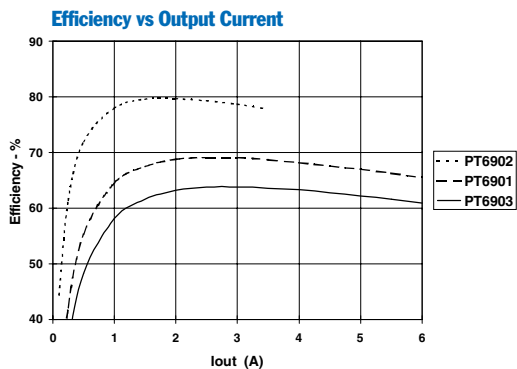
## Specifications

Characteristics (T <sub>a</sub> = 25°C unless noted)	Symbols	Conditions	PT6900 SERIES			Units	
			Min	Typ	Max		
Output Current	I <sub>o</sub>	T <sub>a</sub> = +25°C, natural convection					
		V <sub>in</sub> =5.0V	V <sub>o</sub> = -2.0V / -1.5V	0.1 <sup>(1)</sup> 0.1 <sup>(1)</sup>	— —	6.0 <sup>(2)</sup> 3.5 <sup>(2)</sup>	A
		V <sub>in</sub> =3.3V	V <sub>o</sub> = -2.0V V <sub>o</sub> = -5.2V	0.1 <sup>(1)</sup> 0.1 <sup>(1)</sup>	— —	5.0 <sup>(2)</sup> 2.5 <sup>(2)</sup>	A
Input Voltage Range		0.1A ≤ I <sub>o</sub> ≤ I <sub>max</sub>	PT6901 PT6902/PT6903 PT6904/PT6905	4.5 3.1	— —	5.5 3.6	V
Output Voltage Tolerance	ΔV <sub>o</sub>	Nominal V <sub>in</sub> , I <sub>o</sub> = I <sub>max</sub> 0°C ≤ T <sub>a</sub> ≤ +60°C	V <sub>o</sub> - 0.05	—	V <sub>o</sub> + 0.05	V	
Output Adjust Range	V <sub>o</sub>	Pin 14 to V <sub>o</sub> or GND	V <sub>o</sub> = -2.0V V <sub>o</sub> = -5.2V V <sub>o</sub> = -1.5V	-1.4 -2.7 -1.2	— — —	-4.4 -6.5 -3.4	V
Line Regulation	Reg <sub>line</sub>	Over V <sub>in</sub> range, I <sub>o</sub> =I <sub>max</sub>	—	±0.5	±1.0	%	
Load Regulation	Reg <sub>load</sub>	V <sub>in</sub> =V <sub>nom</sub> , 0.1 ≤ I <sub>o</sub> ≤ I <sub>max</sub>	—	±0.5	±1.0	%	
V <sub>o</sub> Ripple/Noise	V <sub>n</sub>	V <sub>in</sub> = V <sub>nom</sub> , I <sub>o</sub> =I <sub>max</sub>	V <sub>o</sub> = -1.5V / -2.0V V <sub>o</sub> = -5.2V	— —	40 50	— —	mV
Transient Response with C <sub>out</sub> = 330μF	t <sub>tr</sub>	I <sub>o</sub> step between 0.5xI <sub>max</sub> and I <sub>max</sub>	—	200	—	μSec	
	V <sub>os</sub>	V <sub>o</sub> over/undershoot	—	200	—	mV	
Efficiency	η	V <sub>in</sub> = +5V, I <sub>o</sub> =0.5xI <sub>max</sub>	V <sub>o</sub> = -1.5V	—	65	—	%
			V <sub>o</sub> = -2.0V	—	70	—	
		V <sub>in</sub> = +3.3V, I <sub>o</sub> =0.5xI <sub>max</sub>	V <sub>o</sub> = -5.2V	—	77	—	
			V <sub>o</sub> = -2.0V	—	67	—	%
			V <sub>o</sub> = -5.2V	—	75	—	
Switching Frequency	f <sub>o</sub>	Over V <sub>in</sub> and I <sub>o</sub> ranges	500	—	600	kHz	
Absolute Maximum Operating Temperature Range	T <sub>a</sub>	Over V <sub>in</sub> Range	0	—	+85 <sup>(2)</sup>	°C	
Storage Temperature	T <sub>s</sub>		-40	—	+125	°C	
Weight	—	Vertical/Horizontal	—	28/33	—	grams	

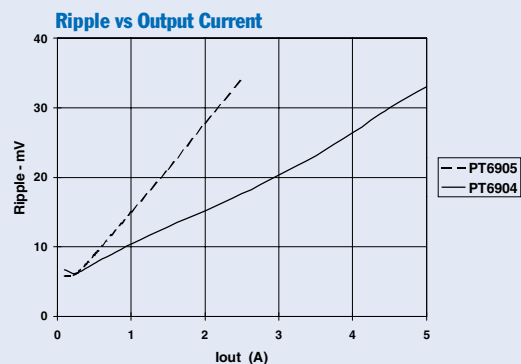
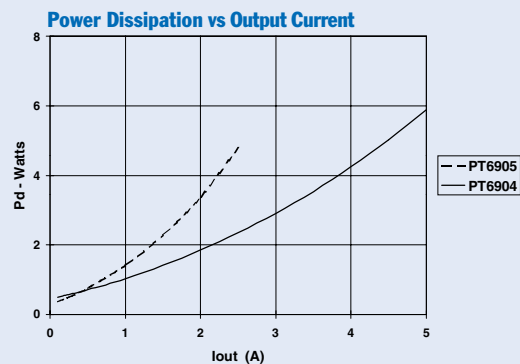
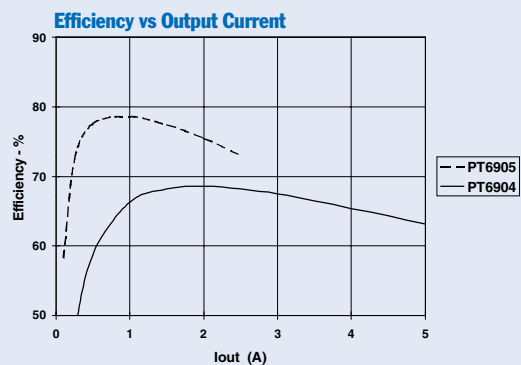
**Notes:** (1) ISR will operate down to no load with reduced specifications.  
(2) See SOA curves or contact the factory for the appropriate derating.

12 Watt 5V/3.3V Input  
Plus to Minus Voltage Converter

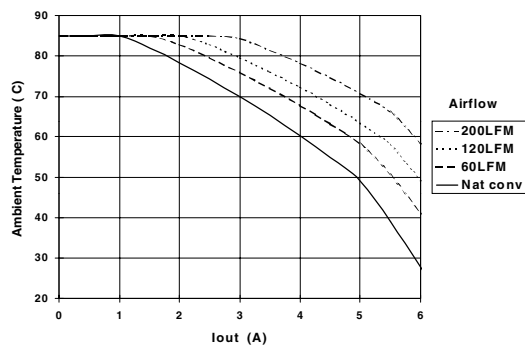
### 5.0V Input Voltage (See Note A)



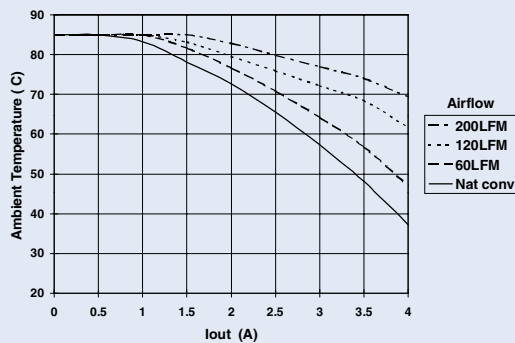
### 3.3V Input Voltage (See Note A)



### Safe Operating Area, PT6901 ( $V_{in} = 5.0V$ ) (See Note B)



### Safe Operating Area, PT6902 ( $V_{in} = 5.0V$ ) (See Note B)



**Note A:** All data listed in the above graphs has been developed from actual products tested at 25°C. This data is considered typical data for the DC-DC Converter.

**Note B:** SOA curves represent operating conditions at which internal components are at or below manufacturer's maximum operating temperatures

## Adjusting the Output Voltage of the PT6900/PT6910 Positive to Negative Converter Series

The negative output voltage of the Power Trends PT6900 Series ISRs may be adjusted higher or lower than the factory trimmed pre-set voltage with the addition of a single external resistor. Table 1 gives the allowable adjustment range for each model in the series as  $V_a$  (min) and  $V_a$  (max).

**Adjust Up:** An increase in the output voltage is obtained by adding a resistor R2, between pin 2 ( $V_o$  adjust) and pin 8 (Remote Sense GND).

**Adjust Down:** Add a resistor (R1), between pin 2 ( $V_o$  adjust) and pin 22 (Remote Sense  $V_o$ ).

Refer to Figure 1 and Table 2 for both the placement and value of the required resistor, either (R1) or R2 as appropriate.

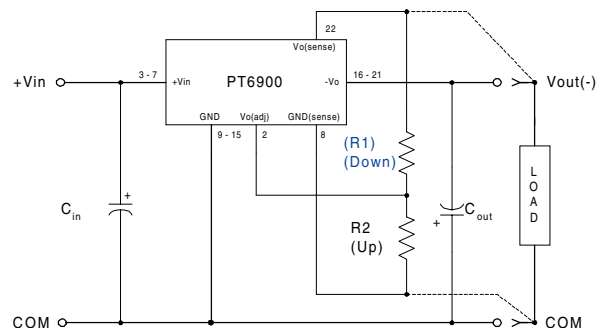
### Notes:

1. Only a single 1% resistor is required in either the (R1) or R2 location. Do not use (R1) and R2 simultaneously. Place the resistor as close to the ISR as possible.
2. Never connect capacitors from  $V_o$  adjust to either GND,  $V_{out}$ , or the Sense pins. Any capacitance added to the  $V_o$  adjust pin will affect the stability of the ISR.
3. If the sense pins are not being used, the resistors (R1) and R2 can be connected to  $V_{out}$  and GND respectively.
4. An increase in the output voltage must be accompanied by a corresponding reduction in the maximum output current. The revised maximum output current must be reduced to the equivalent of 12Watts.

$$\text{i.e. } I_{out}(\text{max}) = \frac{12}{V_a} \text{ A dc,}$$

where  $V_a$  is the adjusted output voltage.

Figure 1



The respective values of (R1) [adjust down], and R2 [adjust up], can also be calculated using the following formulas.

$$(R1) = \frac{24.9 (V_a - V_r)}{(V_o - V_a)} - R_s \text{ k}\Omega$$

$$R2 = \frac{24.9 V_r}{(V_a - V_o)} - R_s \text{ k}\Omega$$

Where:

- $V_o$  = Original output voltage
- $V_a$  = Adjusted output voltage
- $V_r$  = Reference voltage in Table 1
- $R_s$  = The resistance given in Table 1

Table1

PT6900/PT6910 ADJUSTMENT RANGE AND FORMULA PARAMETERS			
Series Pt #			
5.0V Bus	PT6903/13	PT6901/11	PT6902/12
3.3V Bus		PT6904/14	PT6905/15
$V_o$ (nom)	-1.5V	-2.0V	-5.2V
$V_a$ (min)	-1.2V	-1.4V	-2.7V
$V_a$ (max)	-3.4V	-4.5V	-6.5V
$V_r$	-1.0V	-1.0V	-0.92V
$R_s$ (k $\Omega$ )	12.7	10.0	17.4

## PT6900/6910 Series

**Table 2**

**PT6900/PT6910 ADJUSTMENT RESISTOR VALUES**

Series Pt #			
5.0V Bus	PT6903/13	PT6901/11	PT6902/12
3.3V Bus		PT6904/14	PT6905/15
V <sub>o</sub> (nom)	-1.5Vdc	-2.0Vdc	-5.2Vdc
V <sub>a</sub> (req'd)			
-1.2	(3.9)kΩ		
-1.3	(24.7)kΩ		
-1.4	(86.9)kΩ	(6.6)kΩ	
-1.5		(14.9)kΩ	
-1.6	236.0kΩ	(27.4)kΩ	
-1.7	112.0kΩ	(48.1)kΩ	
-1.8	70.3kΩ	(89.6)kΩ	
-1.9	49.6kΩ	(214.0)kΩ	
-2.0	37.1kΩ		
-2.1	28.8kΩ	239.0kΩ	
-2.2	22.9kΩ	115.0kΩ	
-2.3	18.4kΩ	73.0kΩ	
-2.4	15.0kΩ	52.3kΩ	
-2.5	12.2kΩ	39.8kΩ	
-2.6	9.9kΩ	31.5kΩ	
-2.7	8.1kΩ	25.6kΩ	(0.3)kΩ
-2.8	6.5kΩ	21.1kΩ	(2.1)kΩ
-2.9	5.1kΩ	17.7kΩ	(4.0)kΩ
-3.0	3.9kΩ	14.9kΩ	(6.1)kΩ
-3.1	2.9kΩ	12.6kΩ	(8.5)kΩ
-3.2	2.0kΩ	10.8kΩ	(11.0)kΩ
-3.3	1.1kΩ	9.2kΩ	(13.8)kΩ
-3.4	0.4kΩ	7.8kΩ	(16.9)kΩ
-3.5		6.6kΩ	(20.4)kΩ
-3.6		5.6kΩ	(24.3)kΩ
-3.7		4.7kΩ	(28.7)kΩ
-3.8		3.8kΩ	(33.8)kΩ

R1 = (Blue)

R2 = Black

Series Pt #			
5.0V Bus	PT6903/13	PT6901/11	PT6902/12
3.3V Bus		PT6904/14	PT6905/15
V <sub>o</sub> (nom)	-1.5Vdc	-2.0Vdc	-5.2Vdc
V <sub>a</sub> (req'd)			
-3.9		3.1kΩ	(39.7)kΩ
-4.0		2.5kΩ	(46.5)kΩ
-4.1		1.9kΩ	(54.6)kΩ
-4.2		1.3kΩ	(64.3)kΩ
-4.3		0.8kΩ	(76.1)kΩ
-4.4		0.4kΩ	(90.9)kΩ
-4.5		0.0kΩ	(106.0)kΩ
-4.6			(135.0)kΩ
-4.7			(171.0)kΩ
-4.8			(224.0)kΩ
-4.9			(313.0)kΩ
-5.0			(491.0)kΩ
-5.1			(1020.0)kΩ
-5.2			
-5.3			212.0kΩ
-5.4			97.1kΩ
-5.5			59.0kΩ
-5.6			39.9kΩ
-5.7			28.4kΩ
-5.8			20.8kΩ
-5.9			15.3kΩ
-6.0			11.2kΩ
-6.1			8.1kΩ
-6.2			5.5kΩ
-6.3			3.4kΩ
-6.4			1.7kΩ
-6.5			0.2kΩ

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Samples (Requires Login)
PT6901N	LIFEBUY	SIP MODULE	EJH	23	10	TBD	Call TI	Level-1-215C-UNLIM	
PT6902C	LIFEBUY	SIP MODULE	EJK	23	8	TBD	Call TI	Level-1-215C-UNLIM	
PT6902N	LIFEBUY	SIP MODULE	EJH	23	10	TBD	Call TI	Level-1-215C-UNLIM	
PT6903A	OBSOLETE	SIP MODULE	EJJ	23		TBD	Call TI	Call TI	
PT6903C	OBSOLETE	SIP MODULE	EJK	23		TBD	Call TI	Call TI	
PT6903N	OBSOLETE	SIP MODULE	EJH	23		TBD	Call TI	Call TI	
PT6904A	OBSOLETE	SIP MODULE	EJJ	23		TBD	Call TI	Call TI	
PT6904C	OBSOLETE	SIP MODULE	EJK	23		TBD	Call TI	Call TI	
PT6904N	OBSOLETE	SIP MODULE	EJH	23		TBD	Call TI	Call TI	
PT6905N	LIFEBUY	SIP MODULE	EJH	23	10	TBD	Call TI	Level-1-215C-UNLIM	

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

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**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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